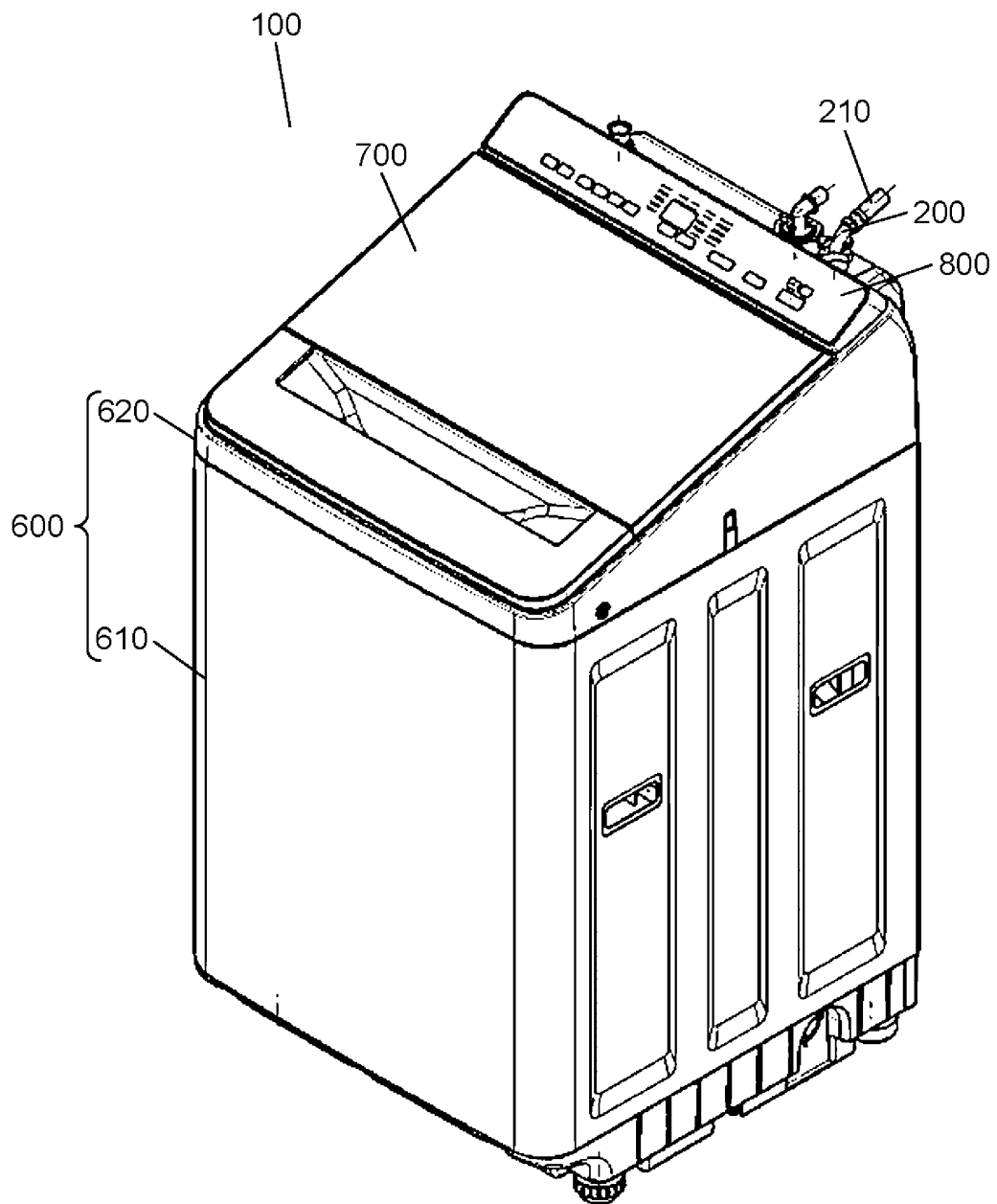
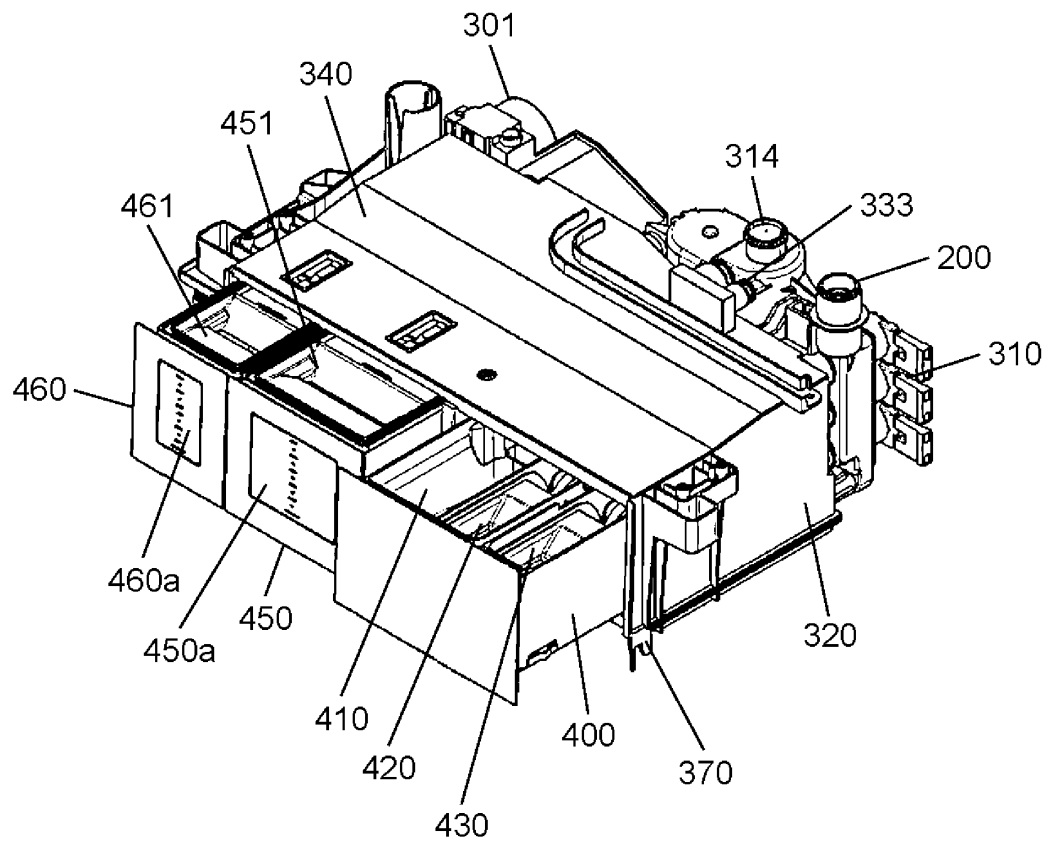


[図1]

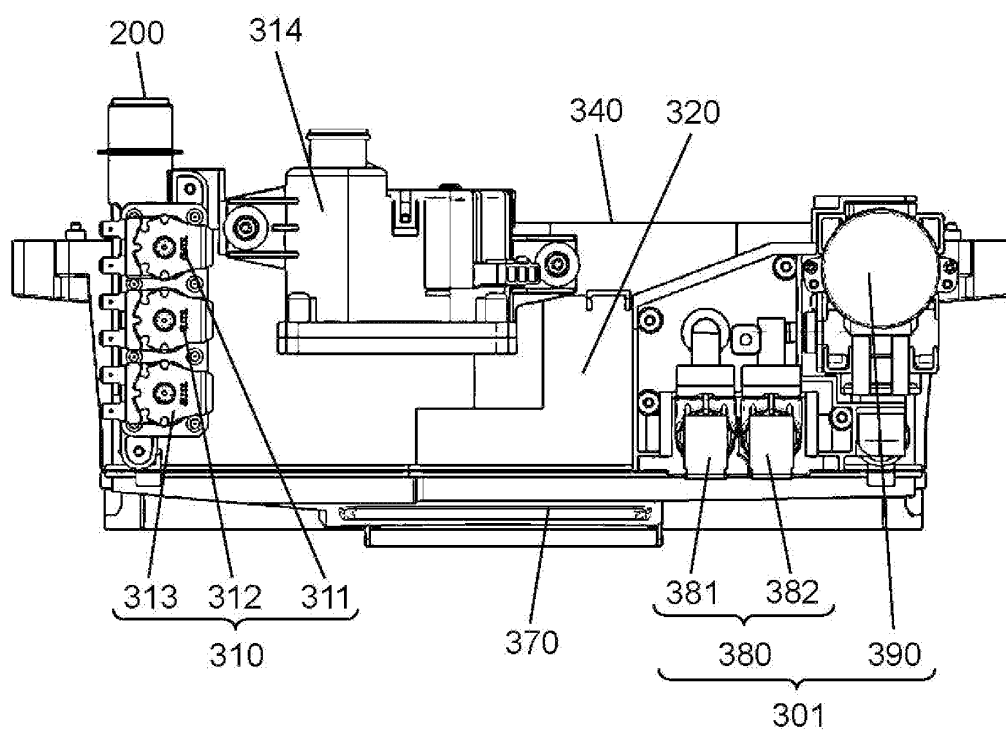




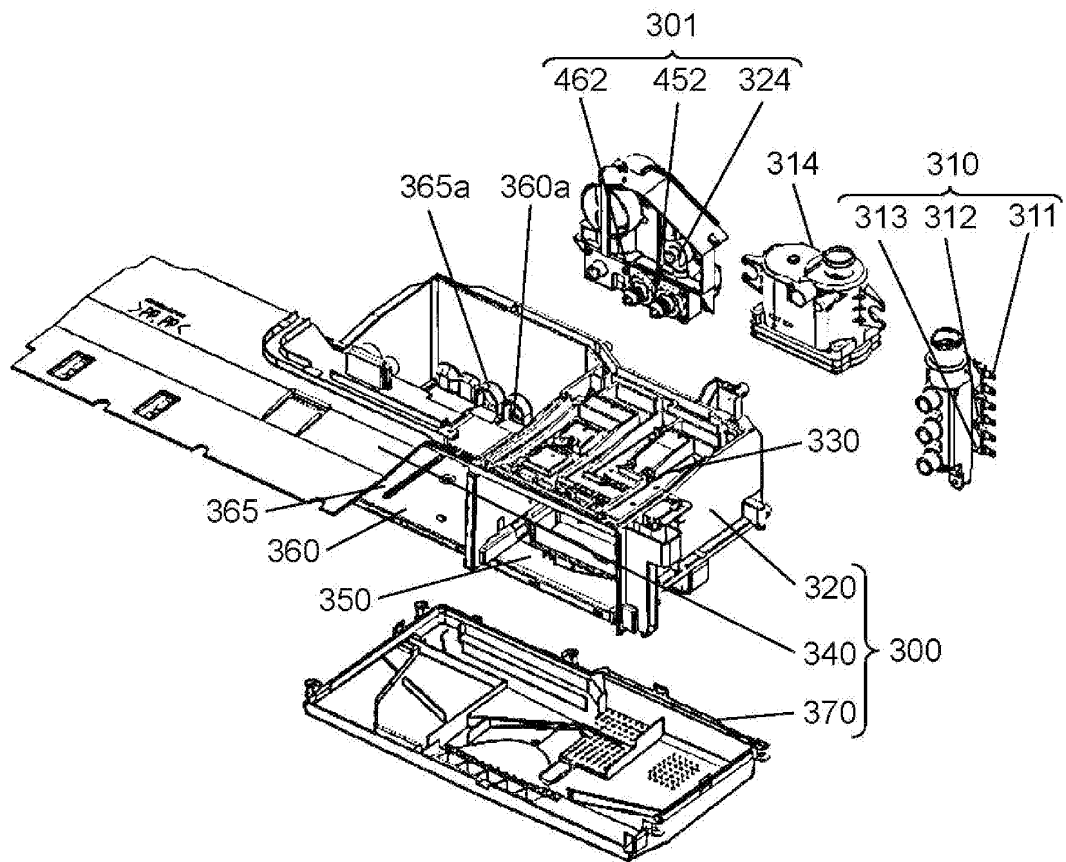
[図3]



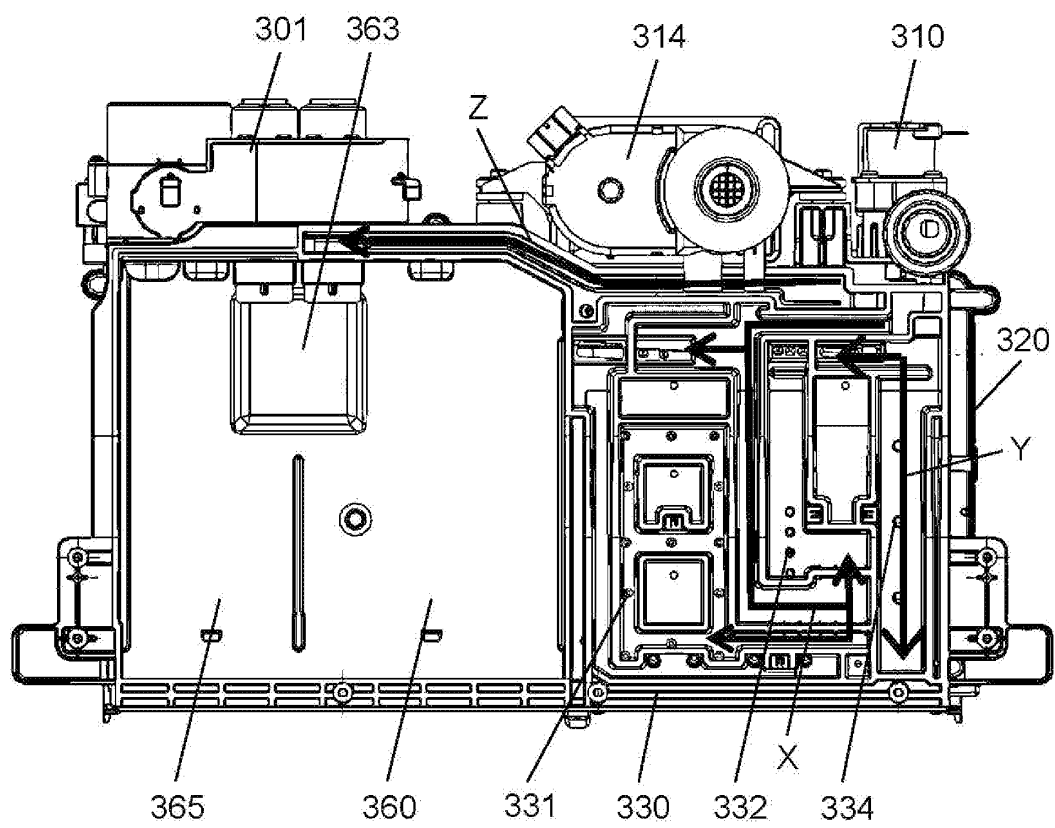
[図4]



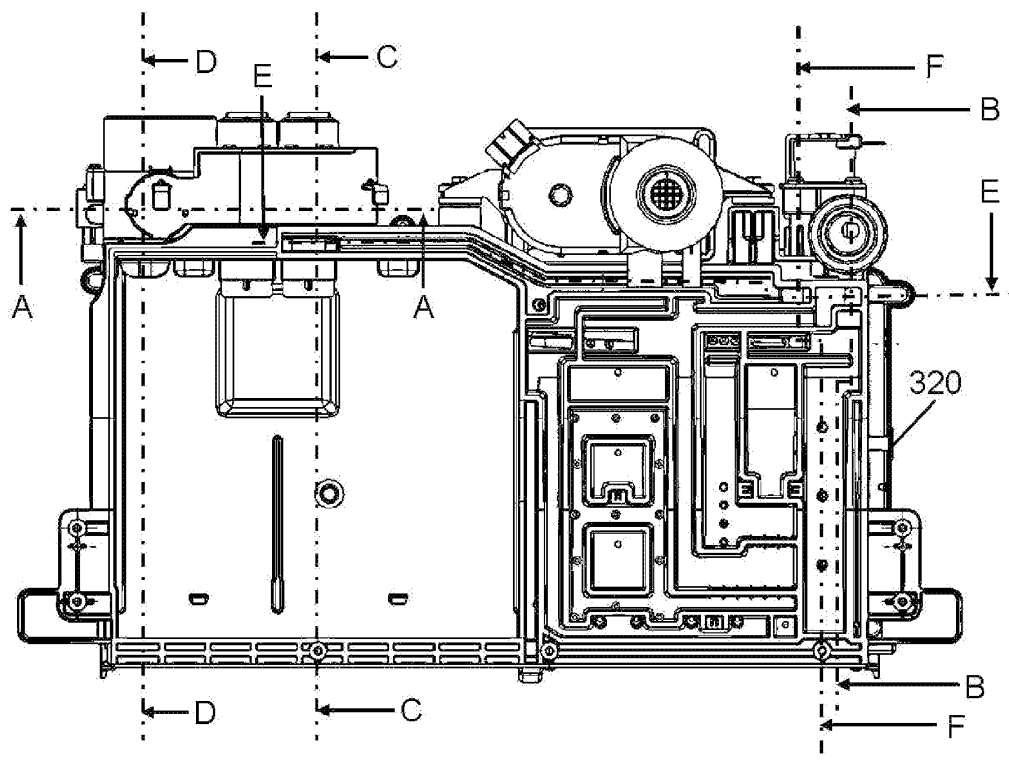
[図5]



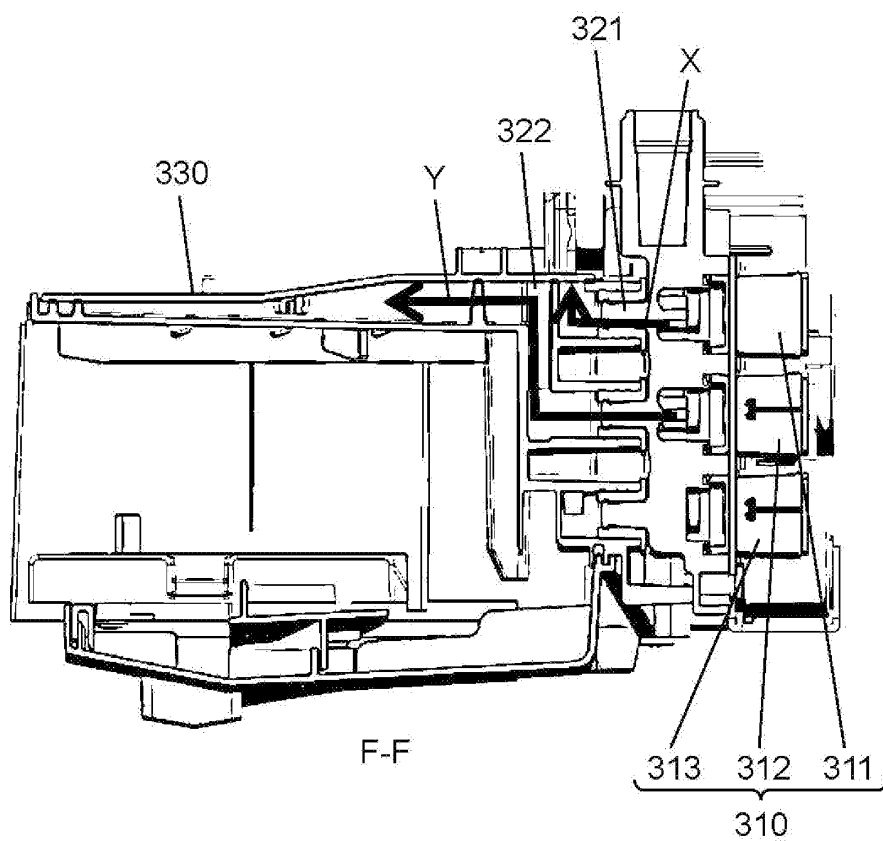
[図6]



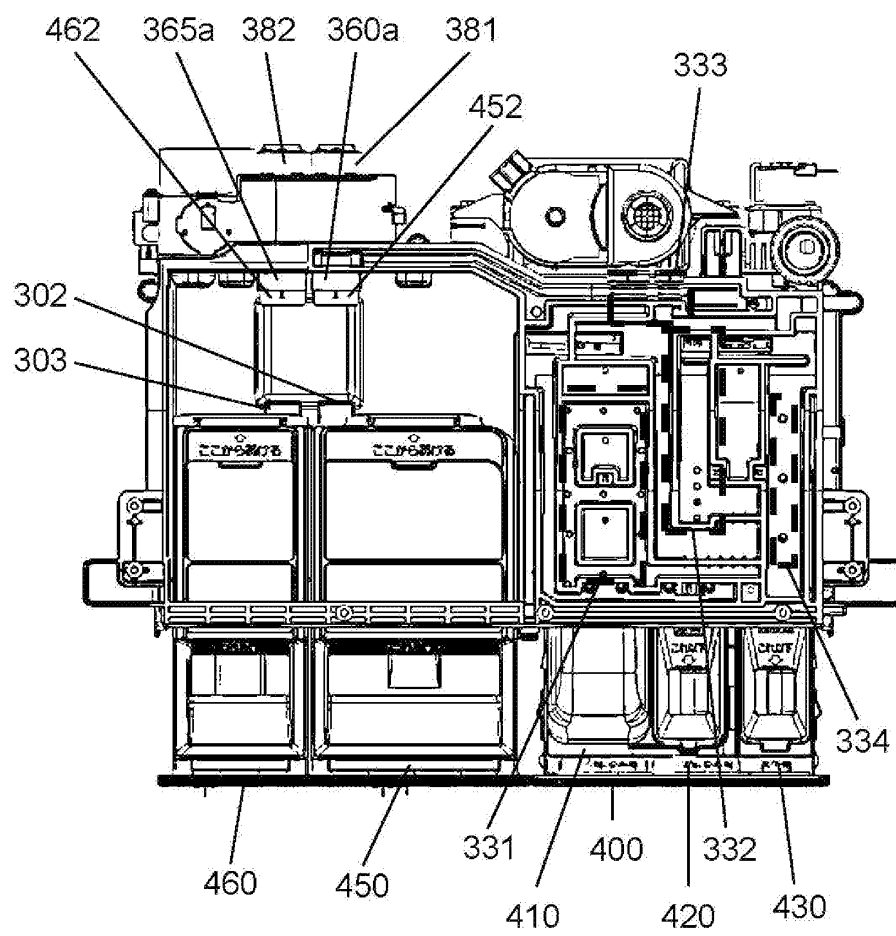
[図7]



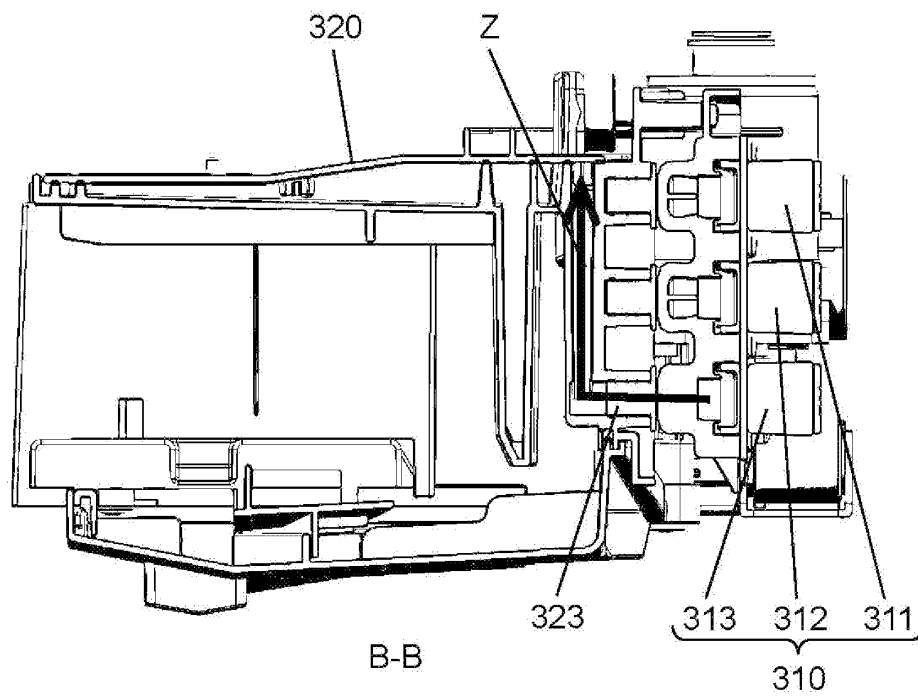
[図8]



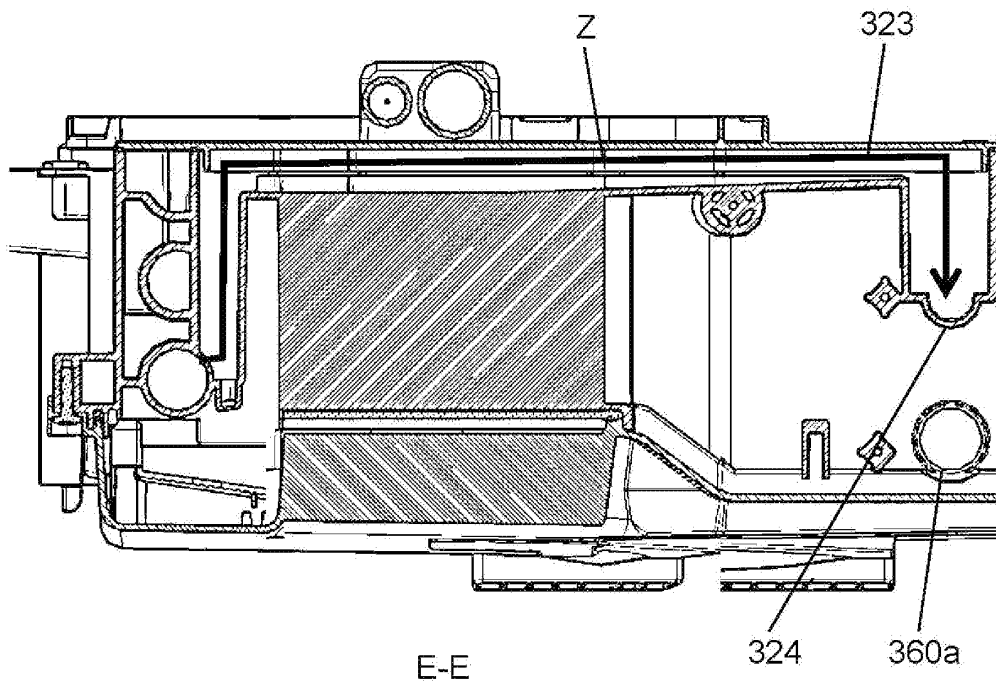
[図9]



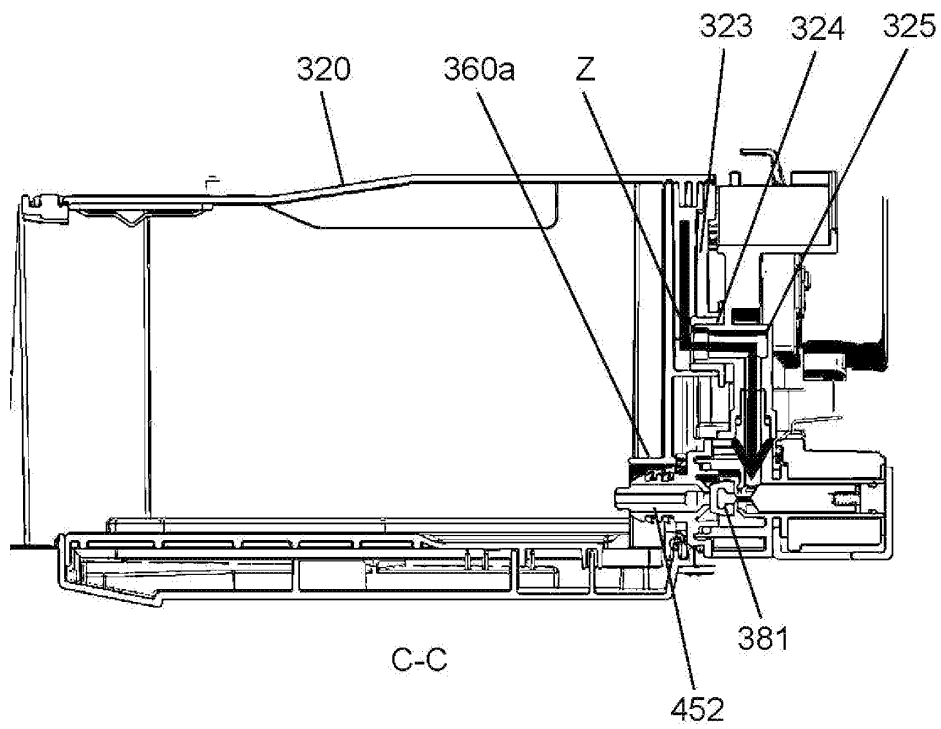
[図10]



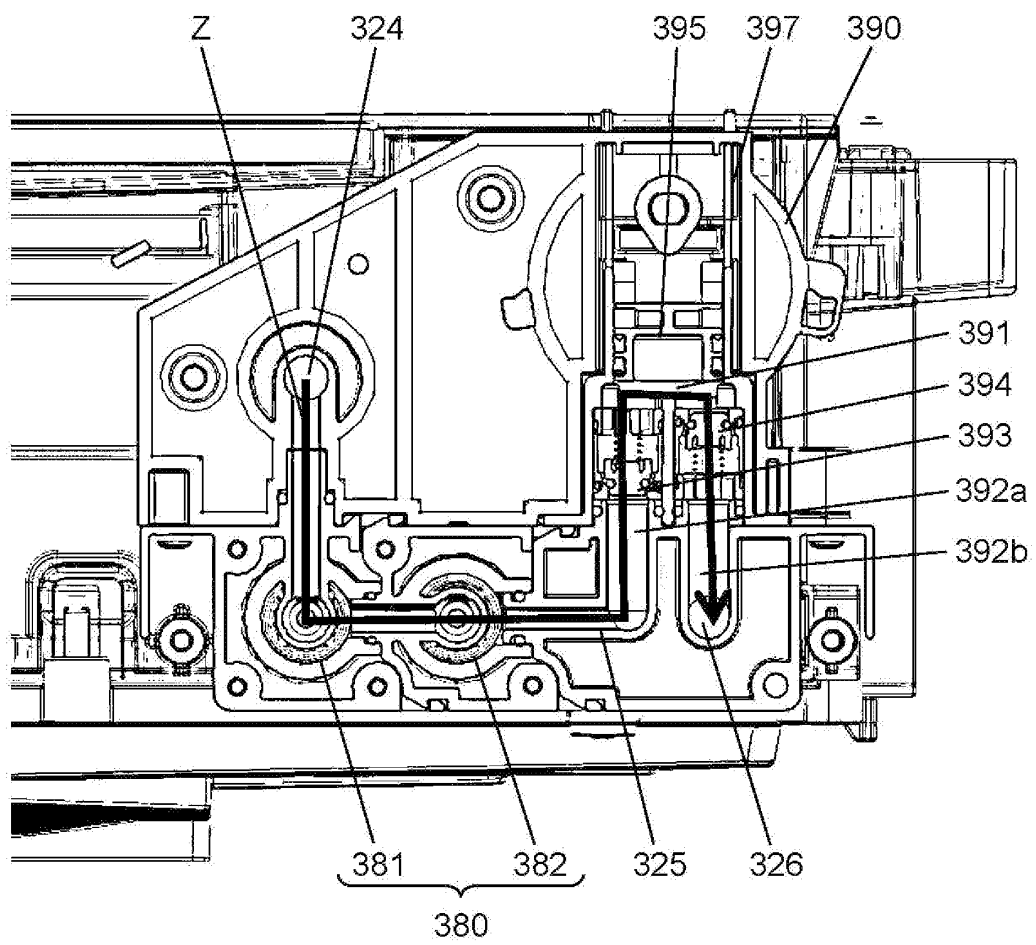
[図11]



[図12]



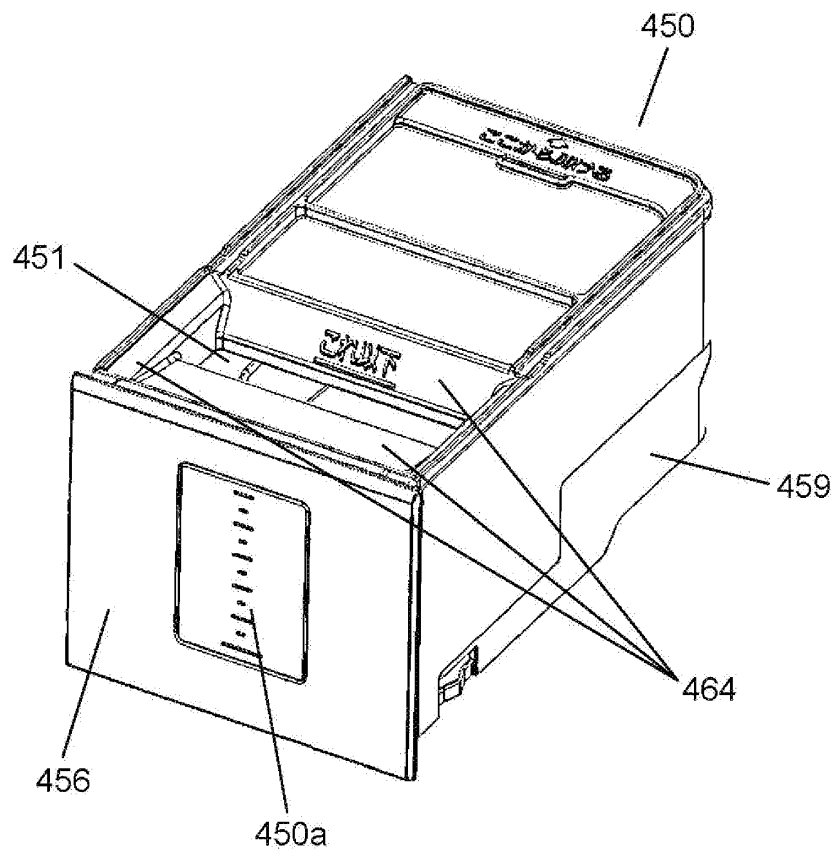
[図13]



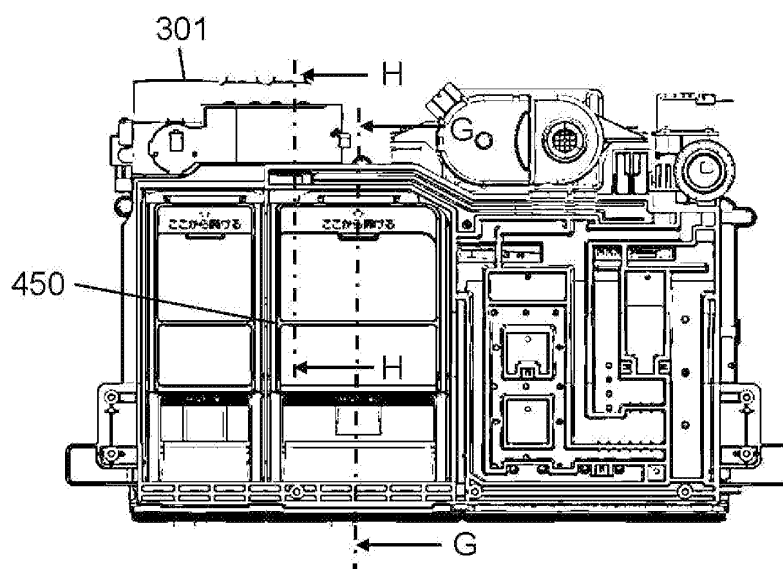
A-A

A detailed cross-sectional view of the device, labeled 'D-D' at the bottom. This view shows the internal components of the device, including the housing, the internal structure, and the connection points for the external components. The view is taken from the side, showing the profile of the device. Key features include the internal cavity, the internal structure, and the connection points for the external components. The view is labeled with 'D-D' at the bottom, indicating the plane of the section.

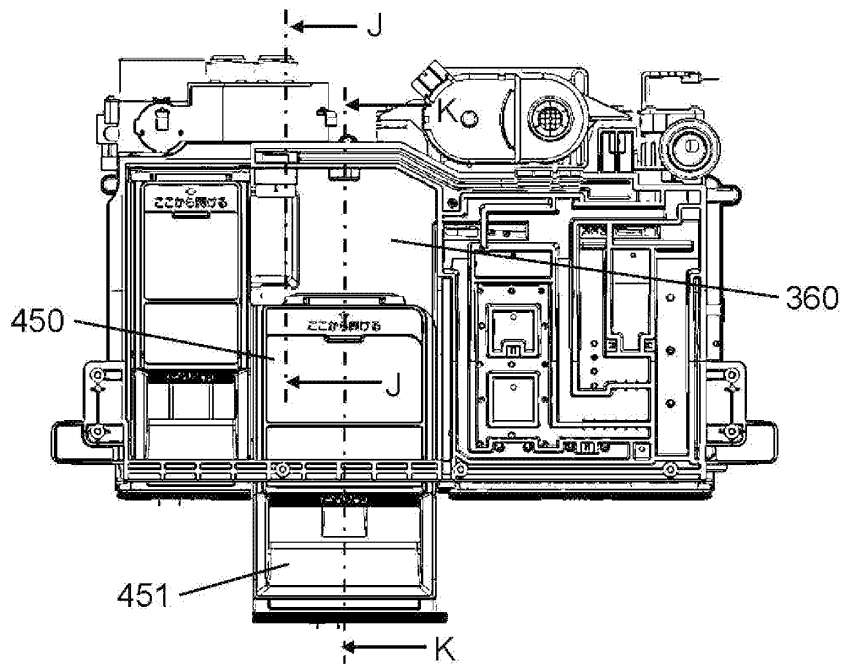
[図16]



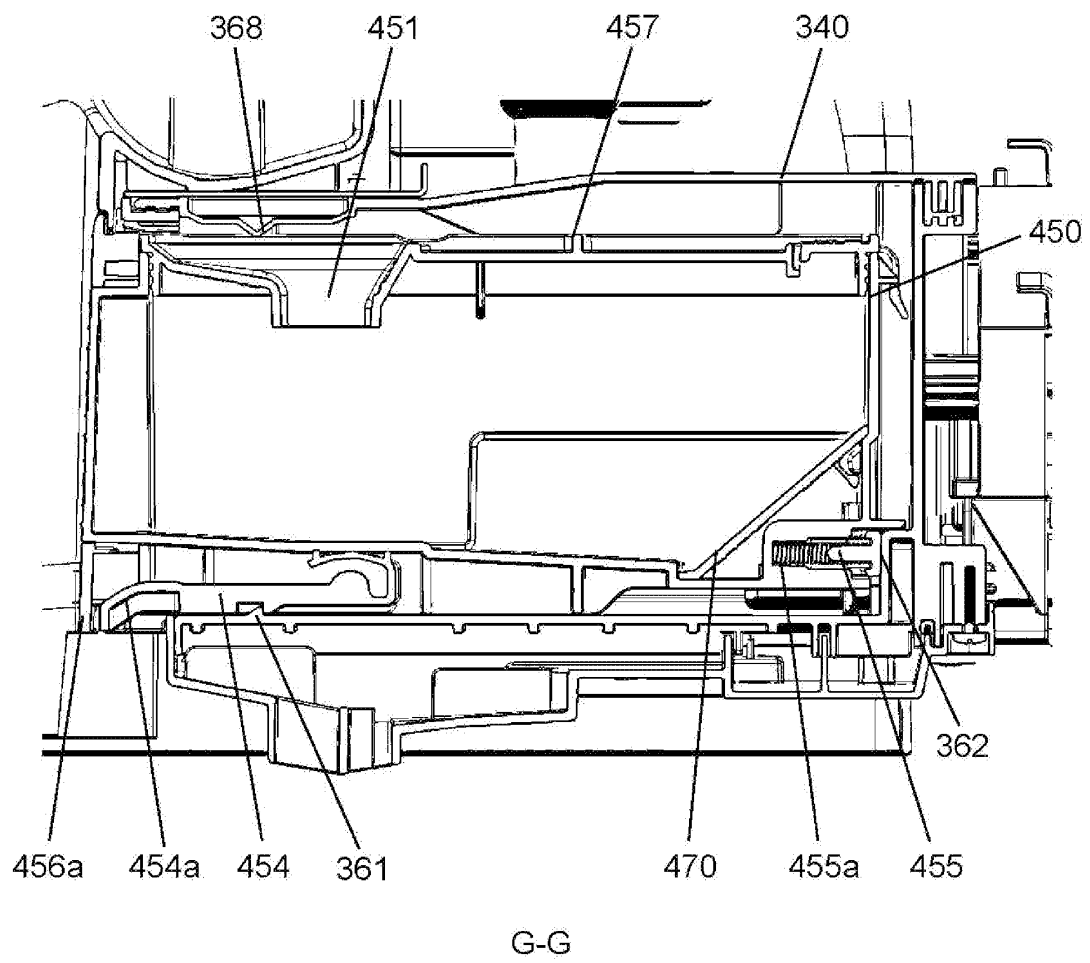
[図17A]



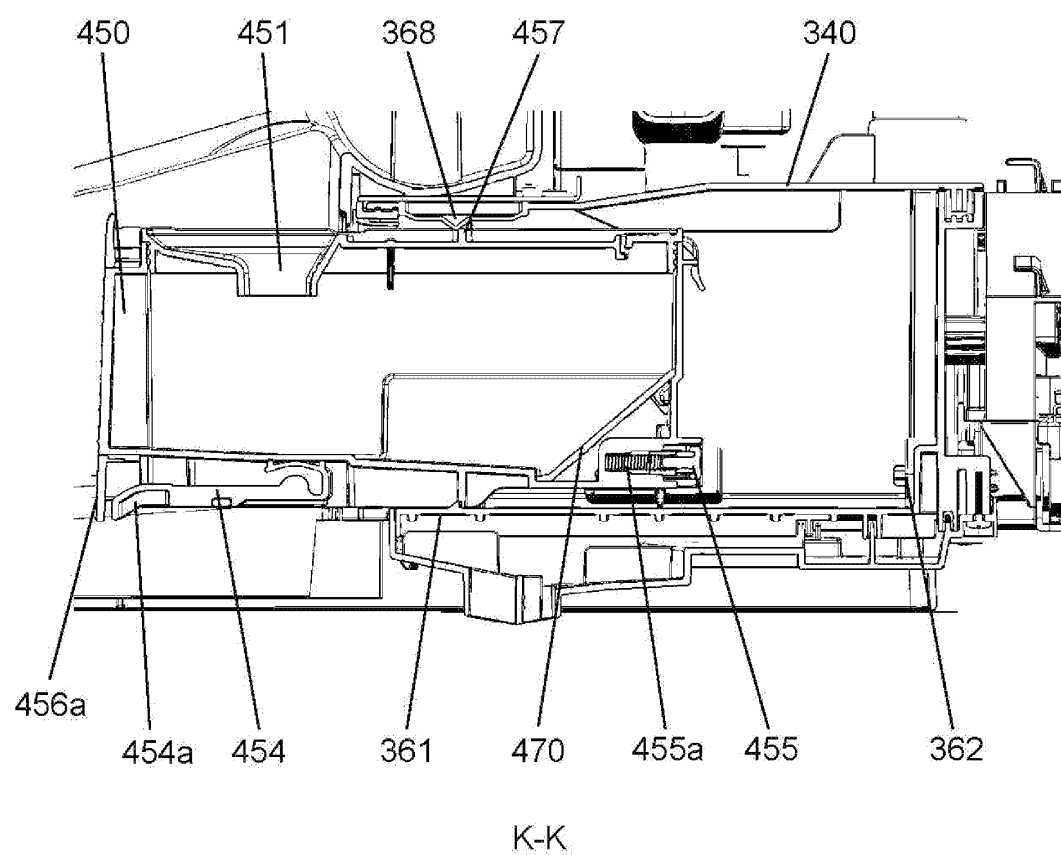
[図17B]



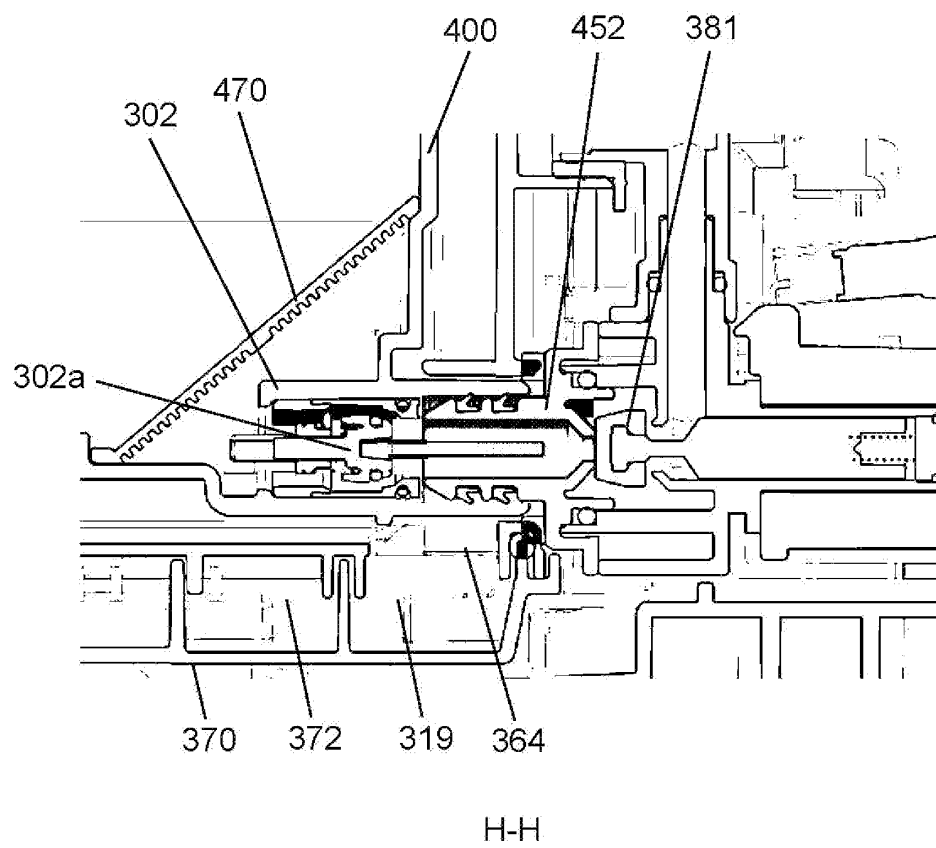
[図18]



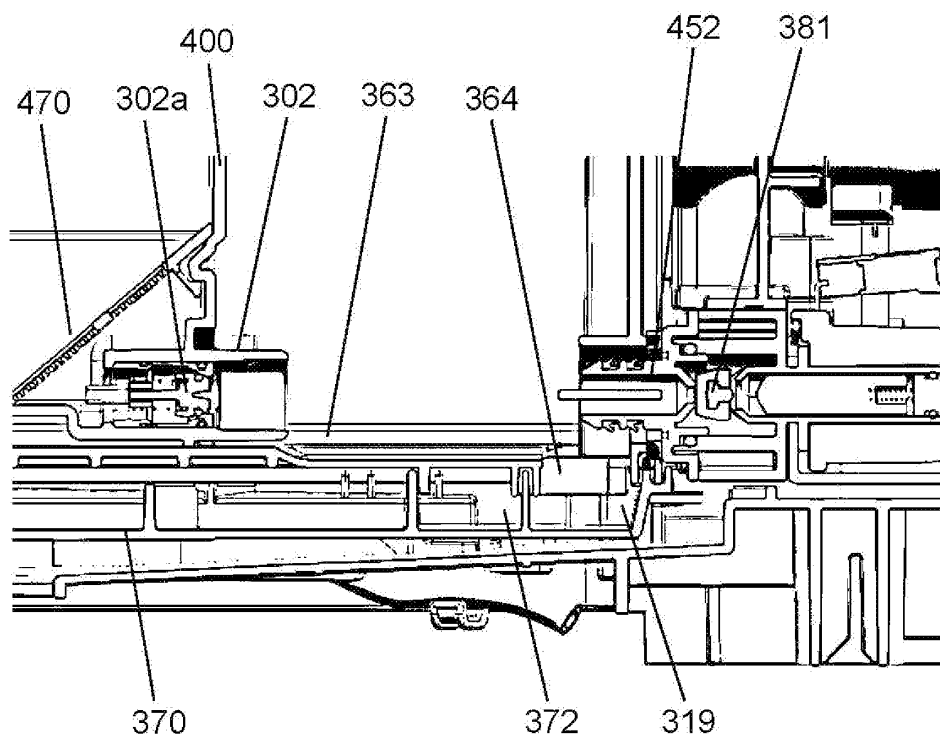
[図19]



[図20]

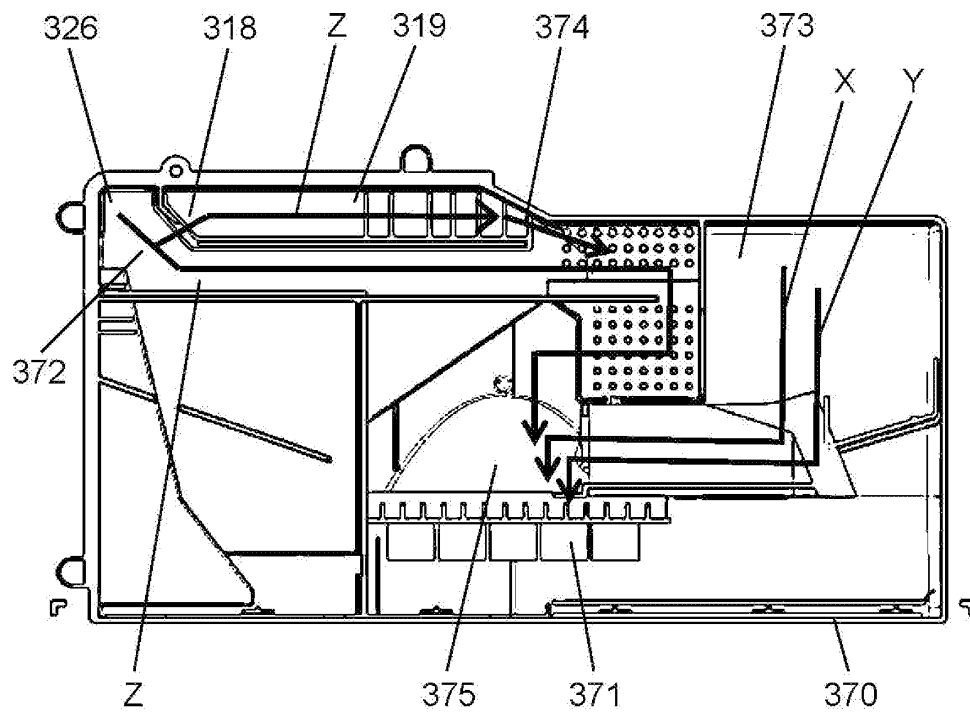


[図21]

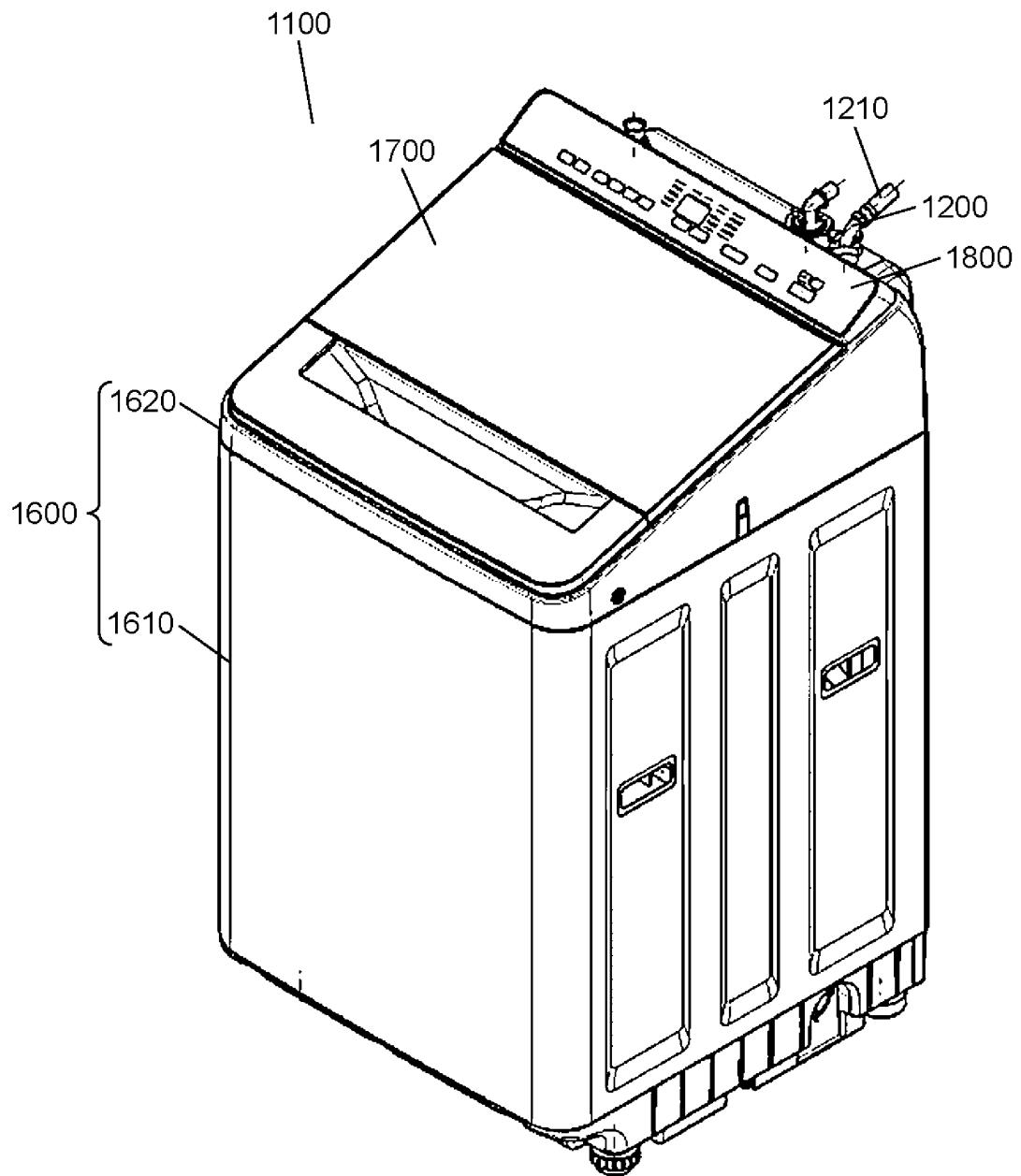


J-J

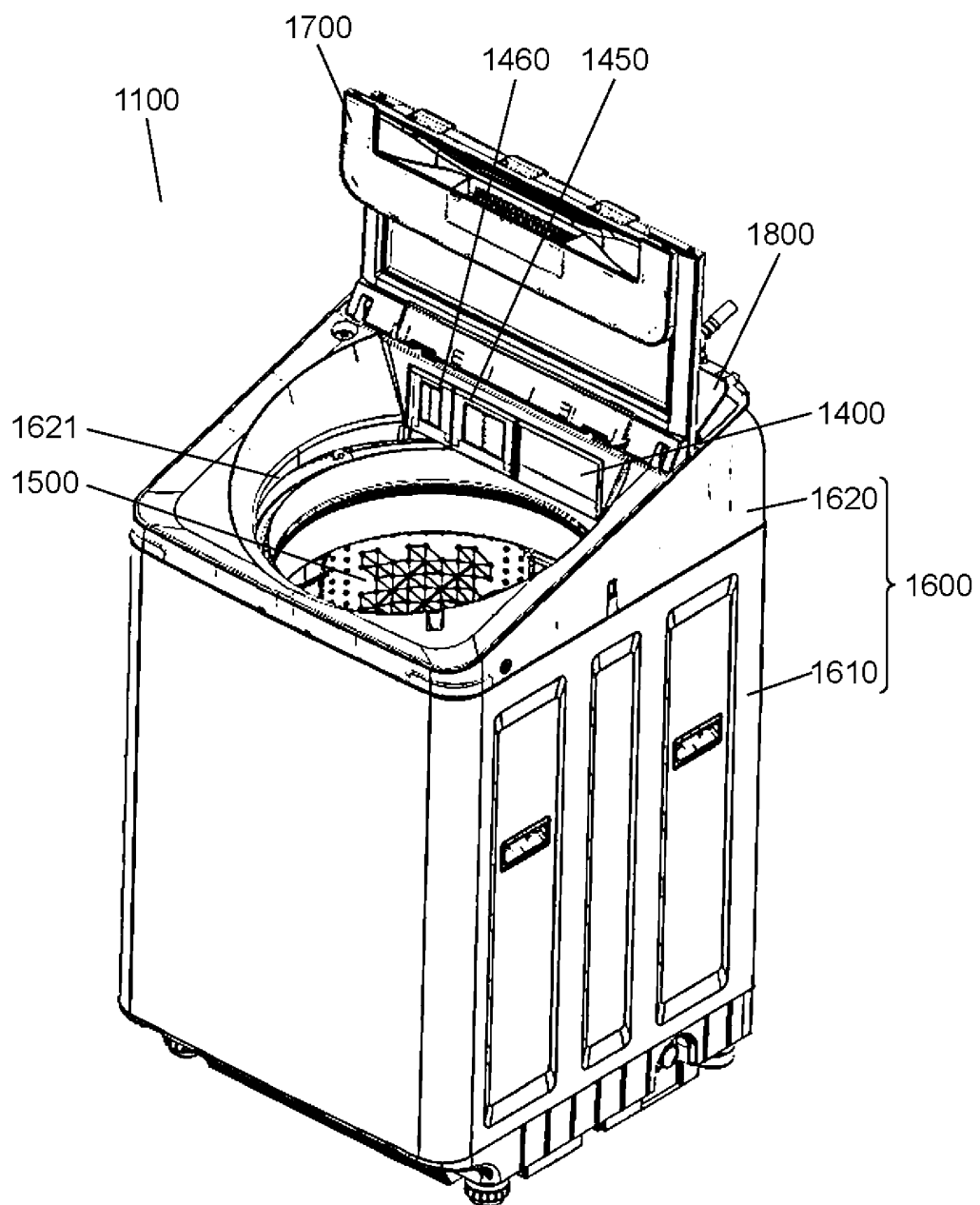
[図22]



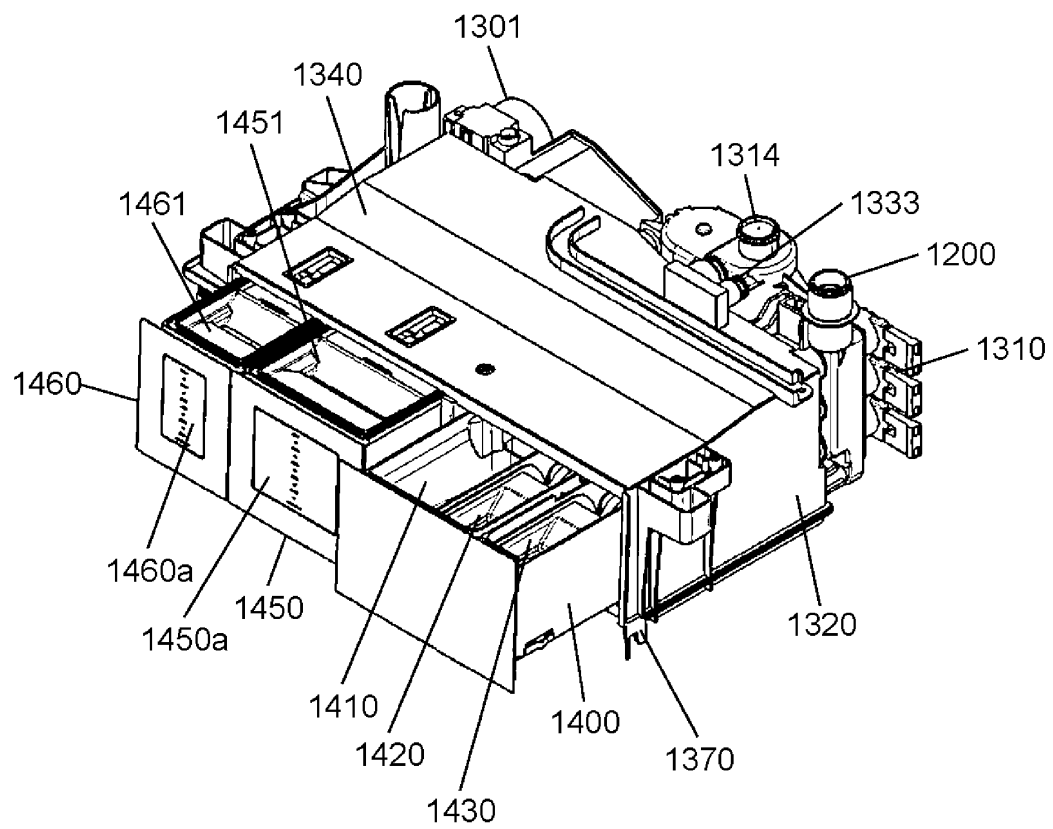
[図23]



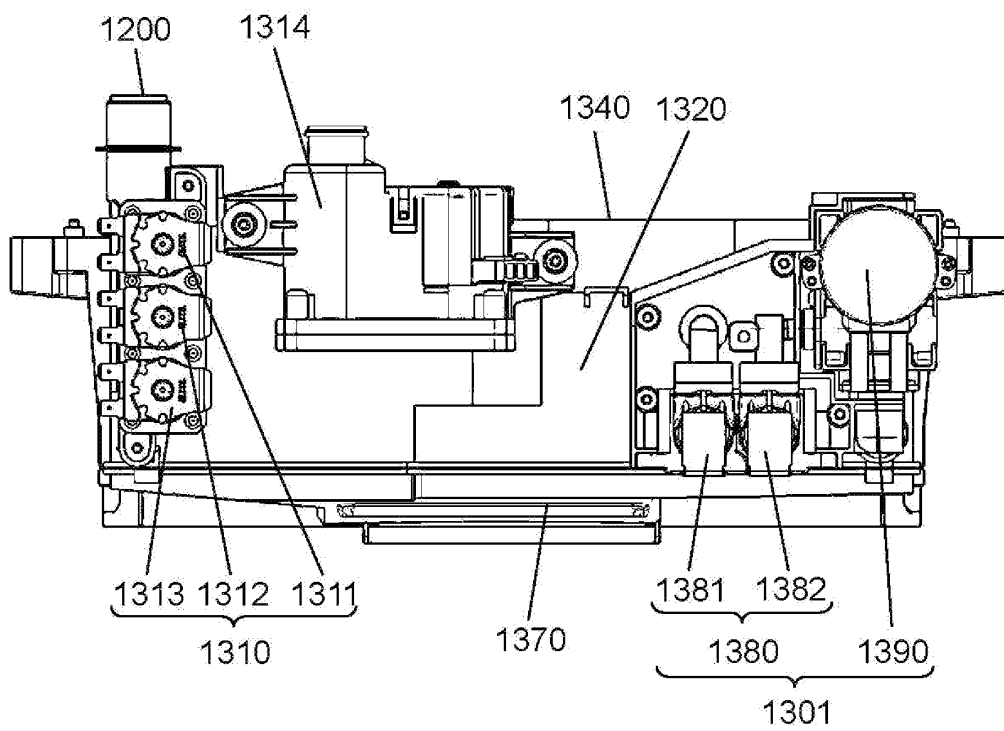
[図24]



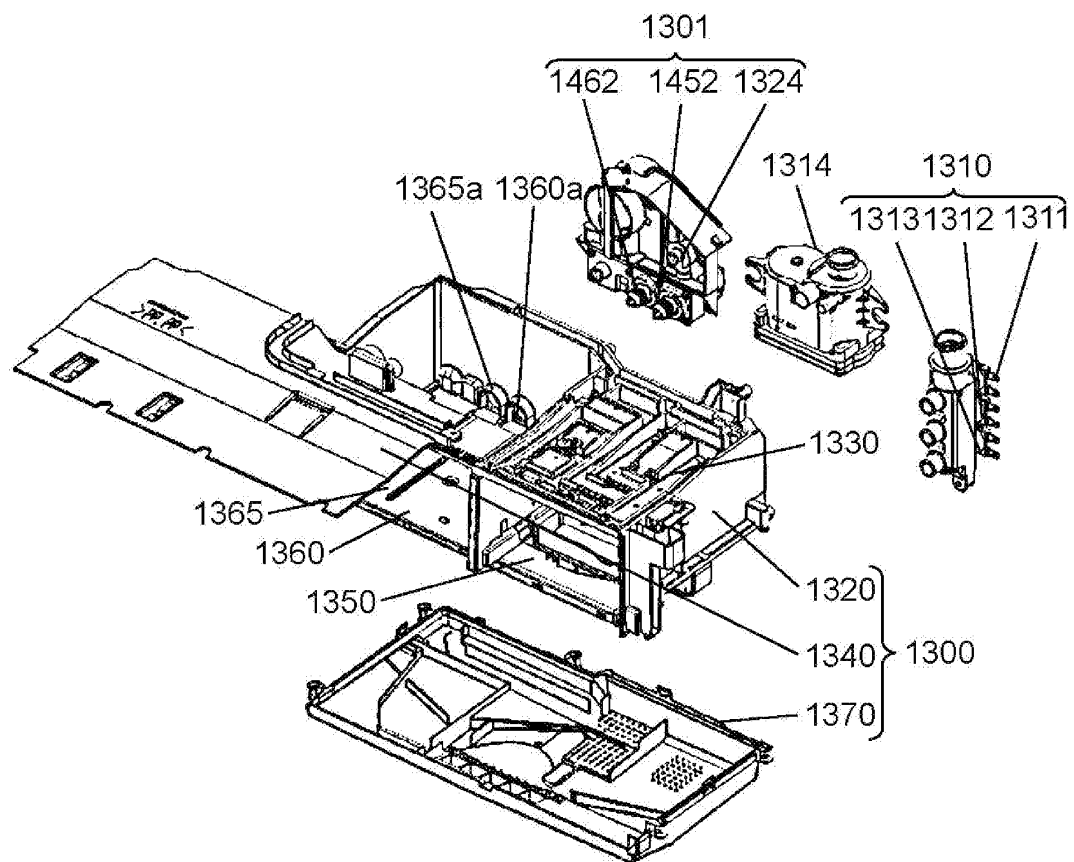
[図25]



[図26]

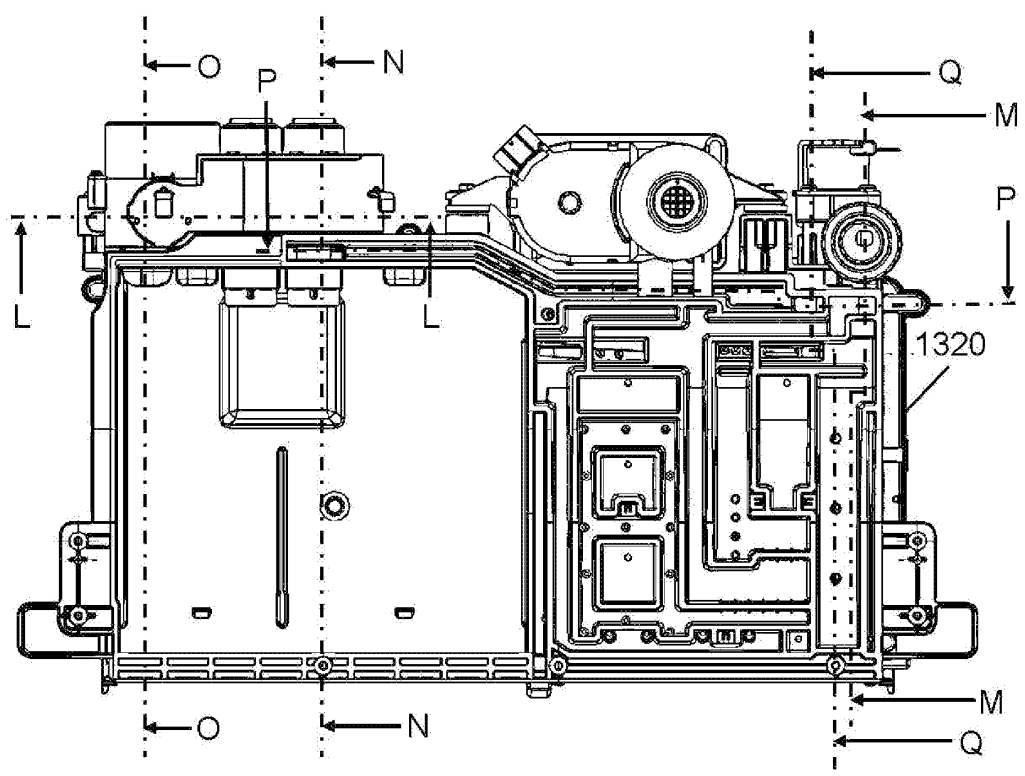


[図27]

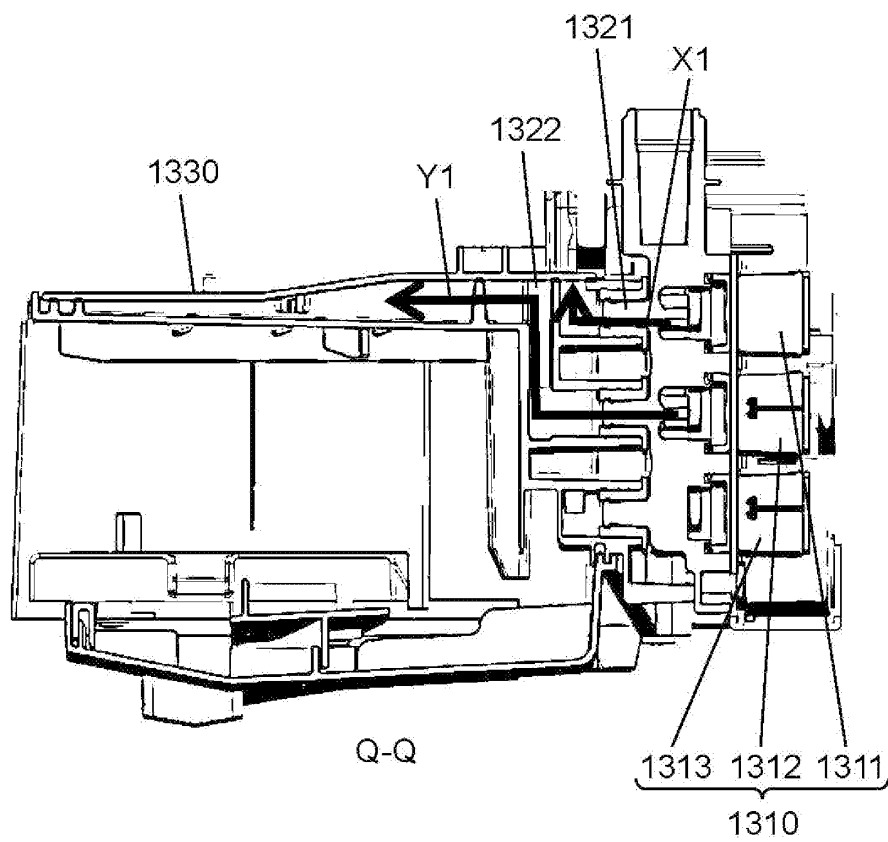




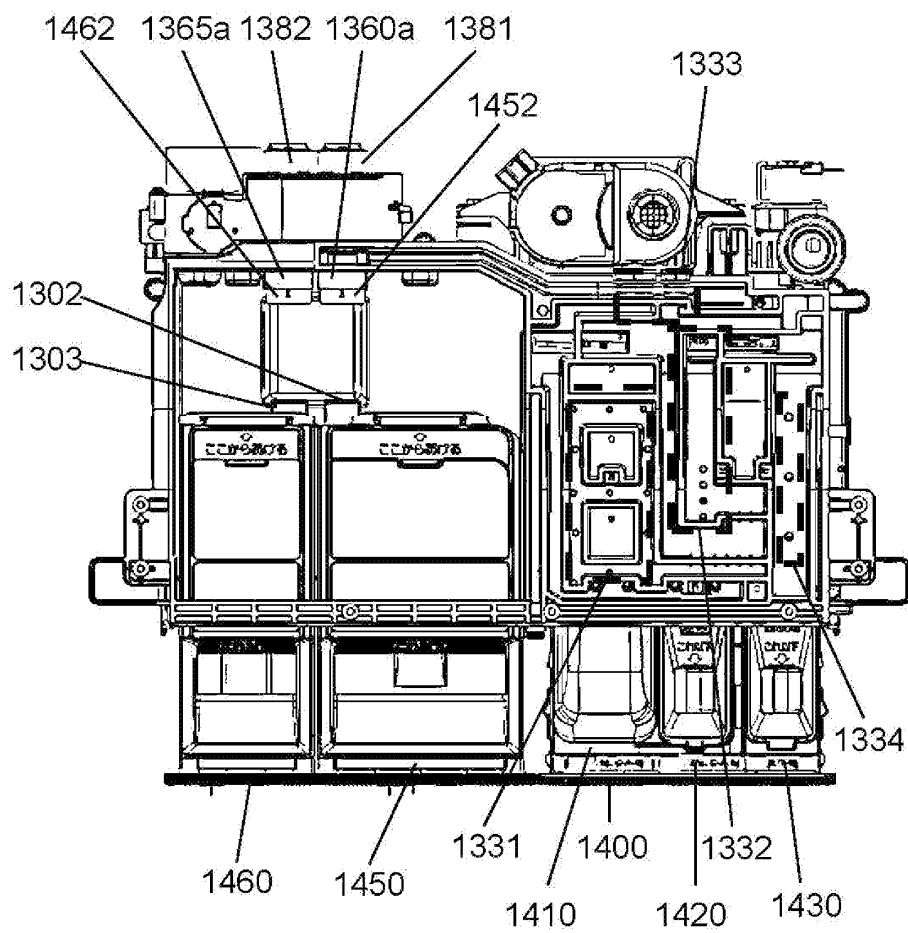
[図29]



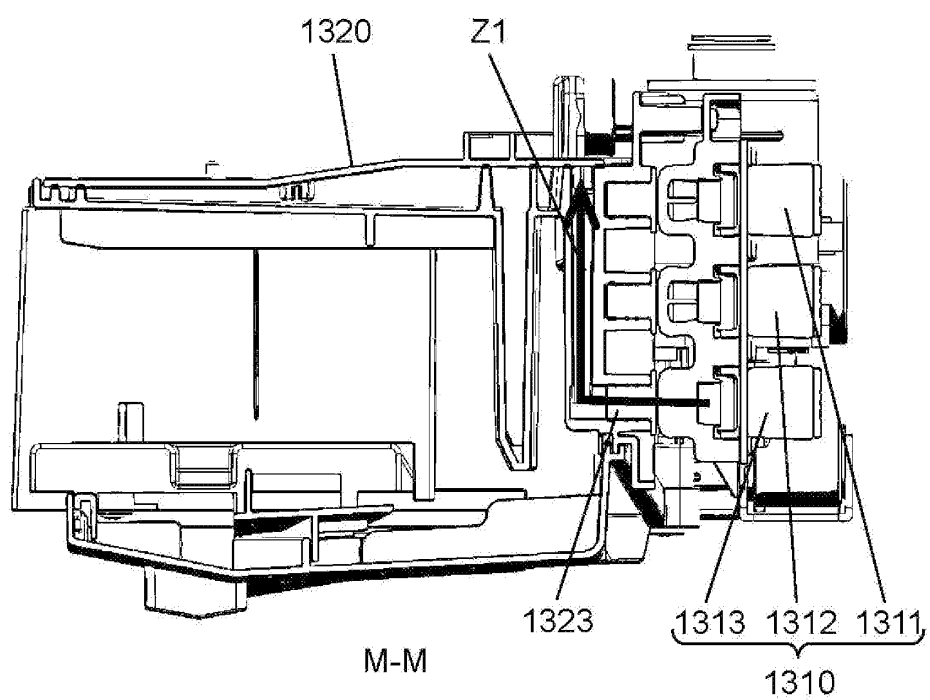
[図30]



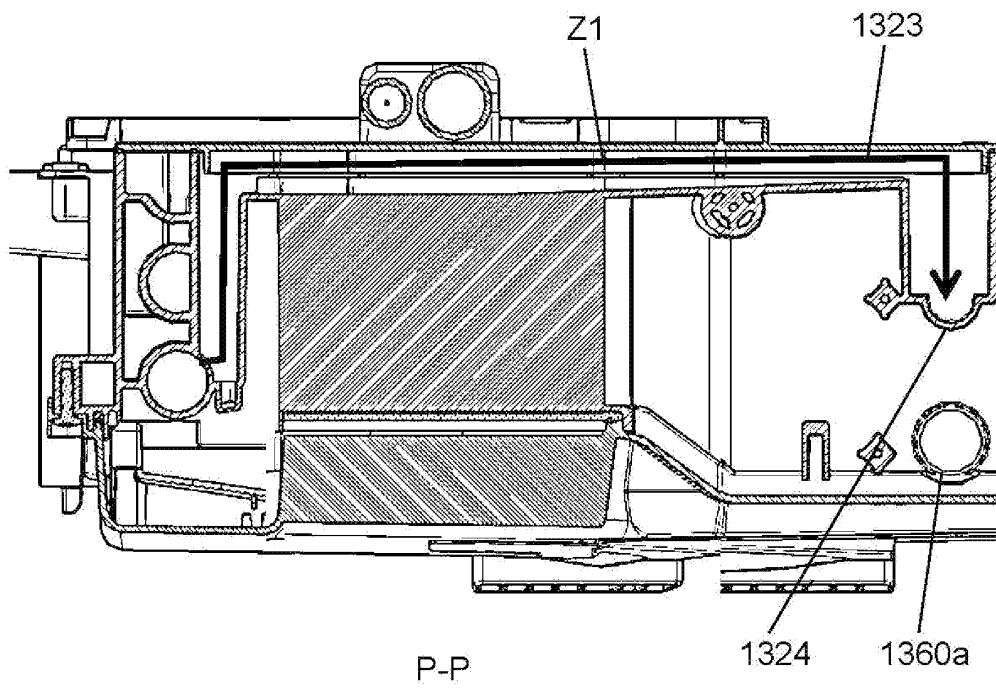
[図31]



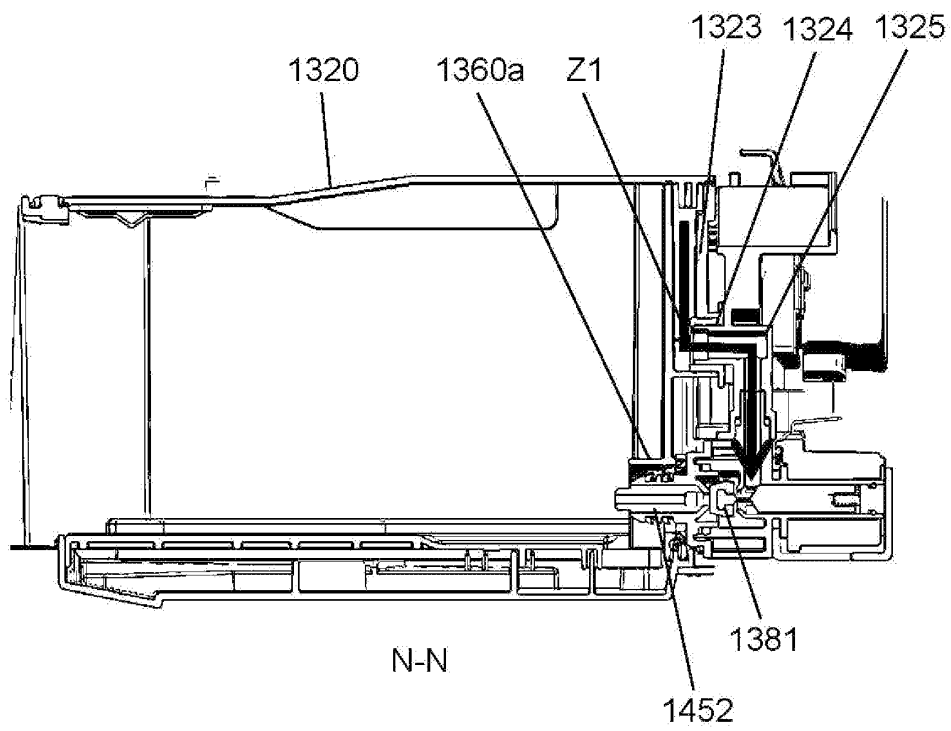
[図32]



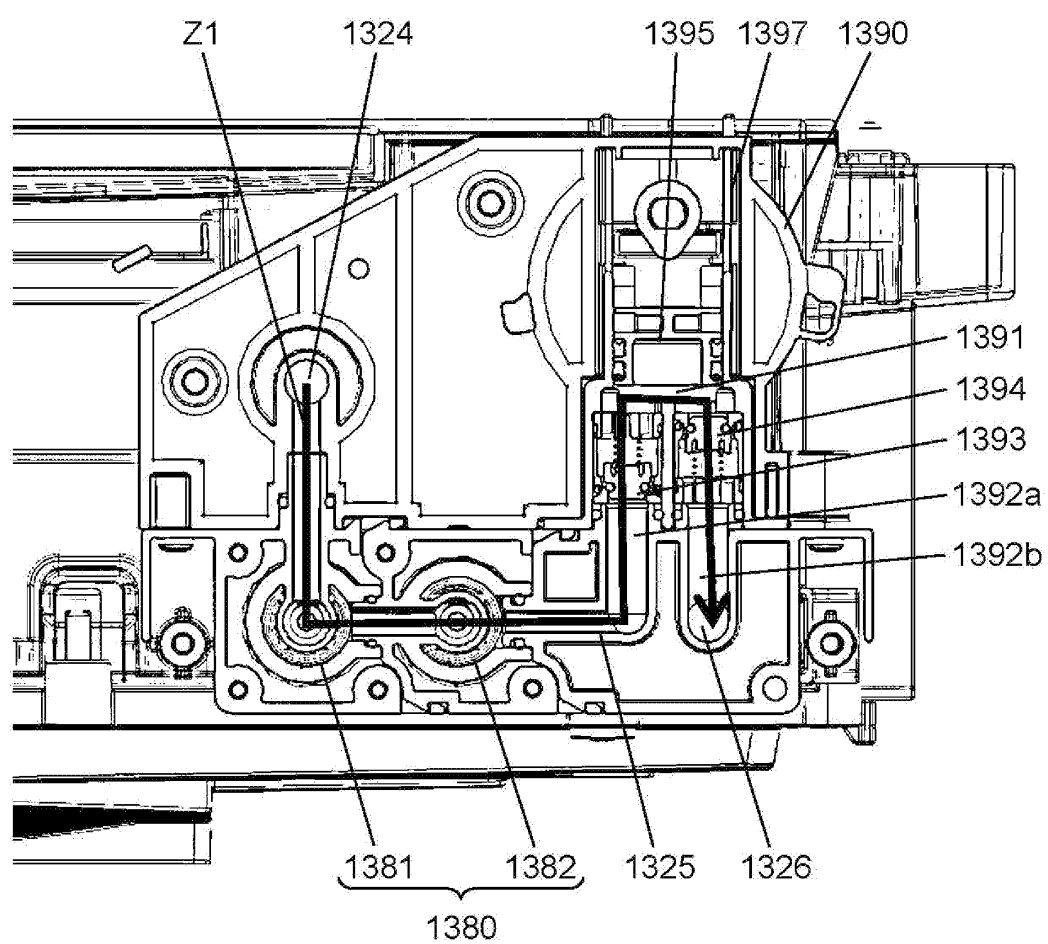
[図33]



[図34]

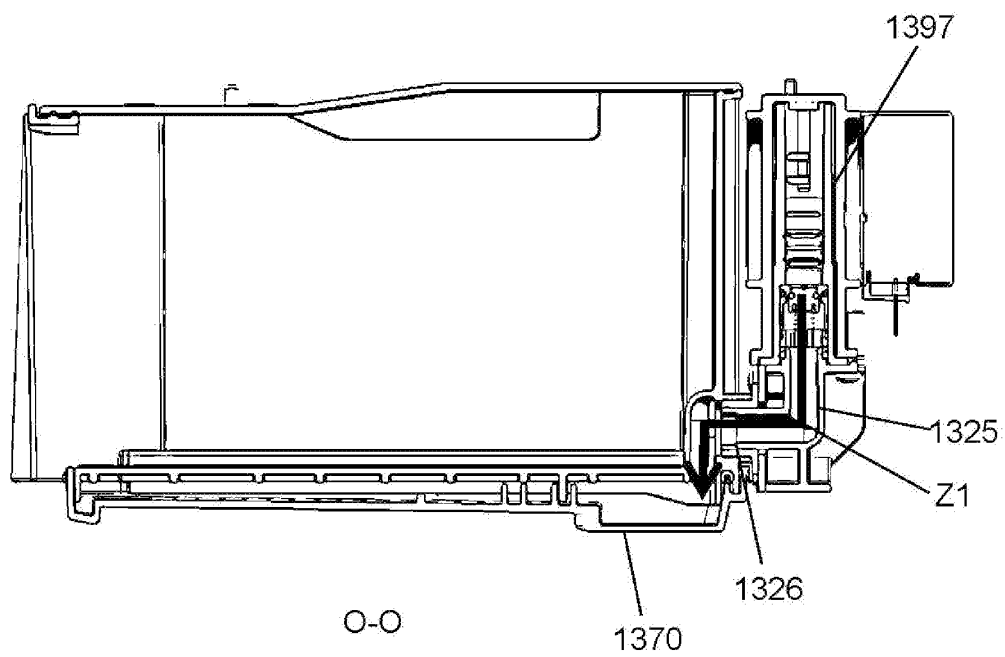


[図35]

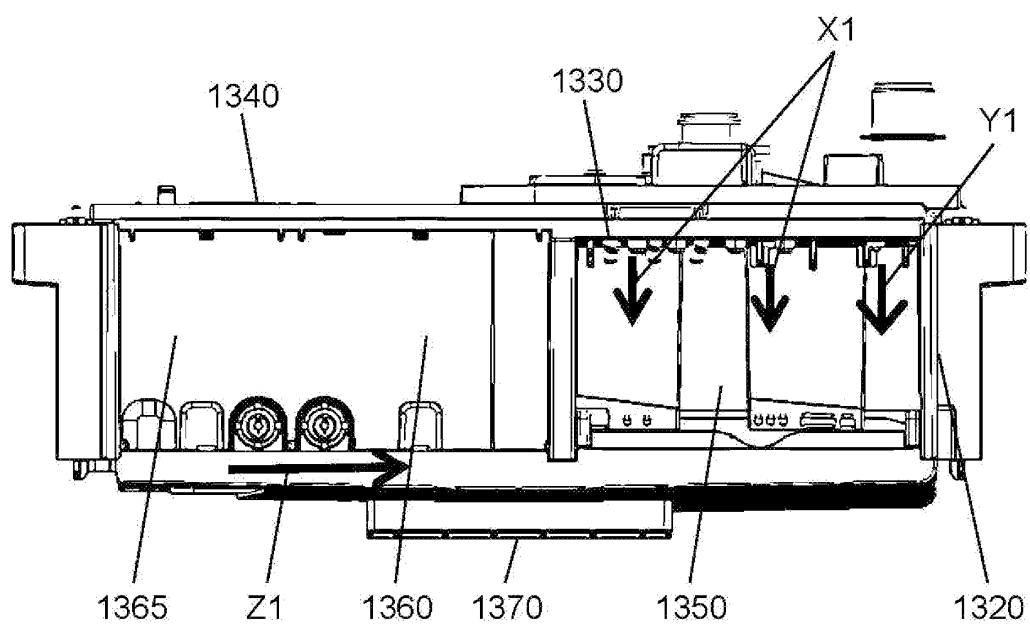


L-L

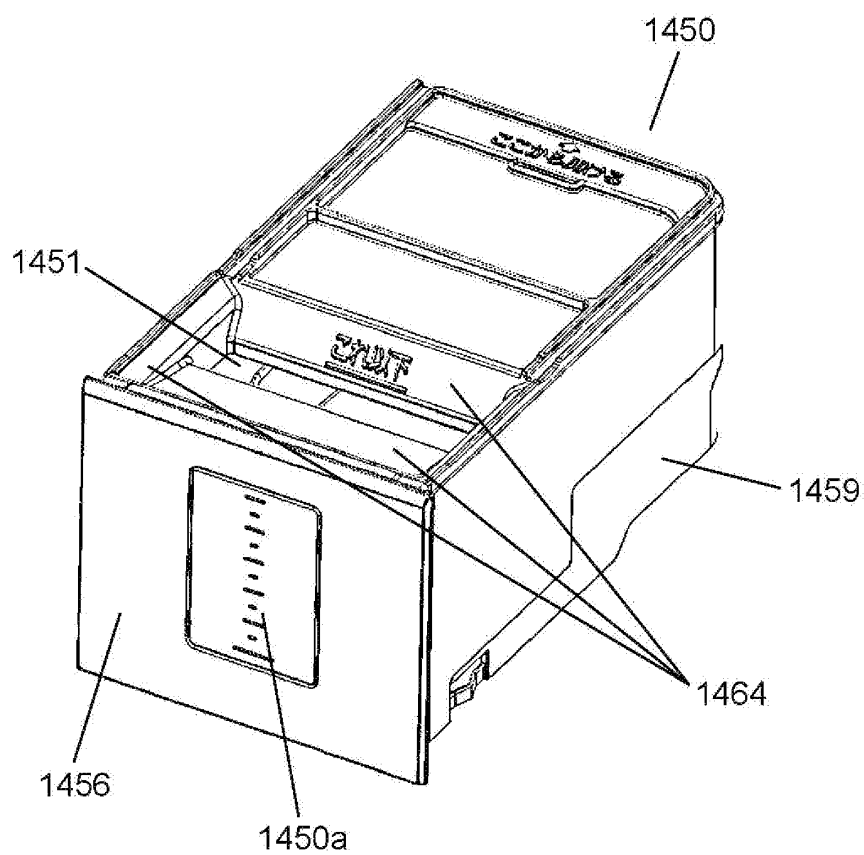
[図36]



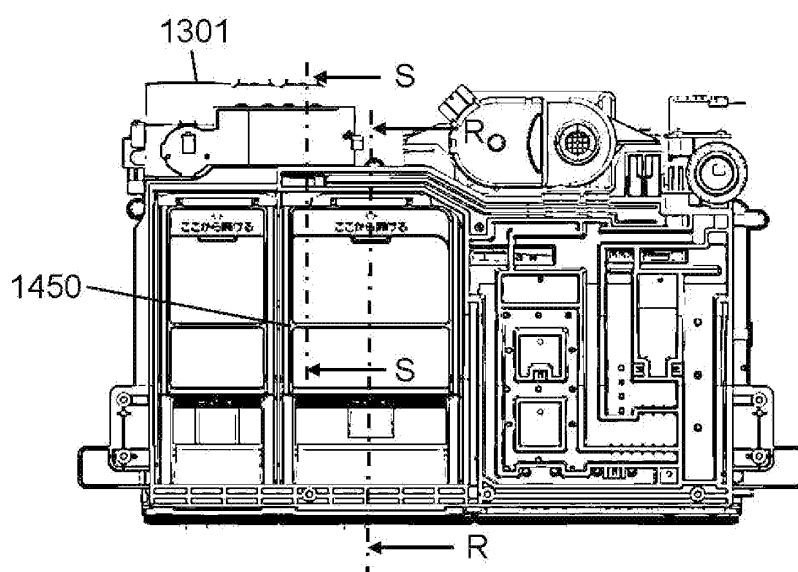
[図37]



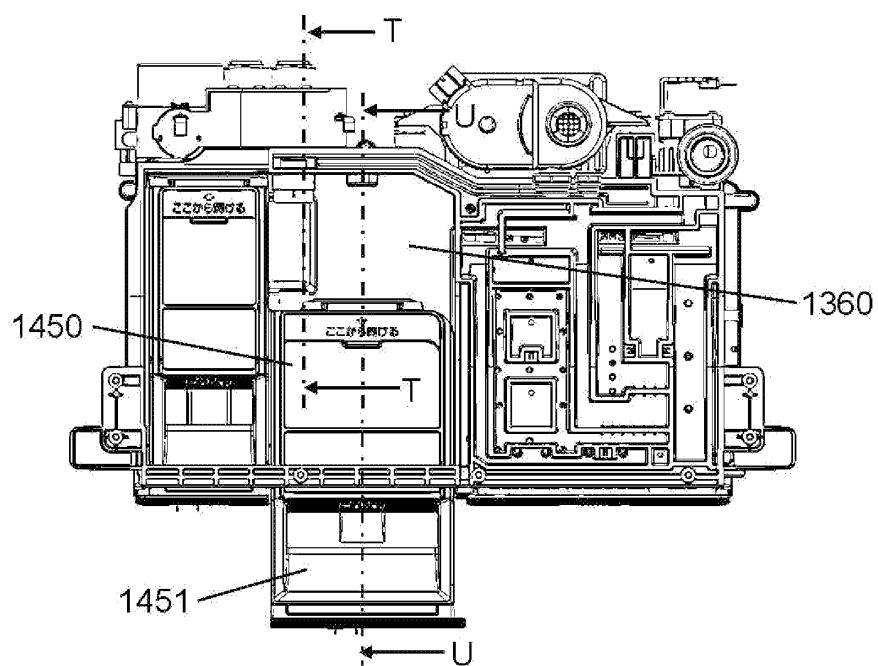
[図38]



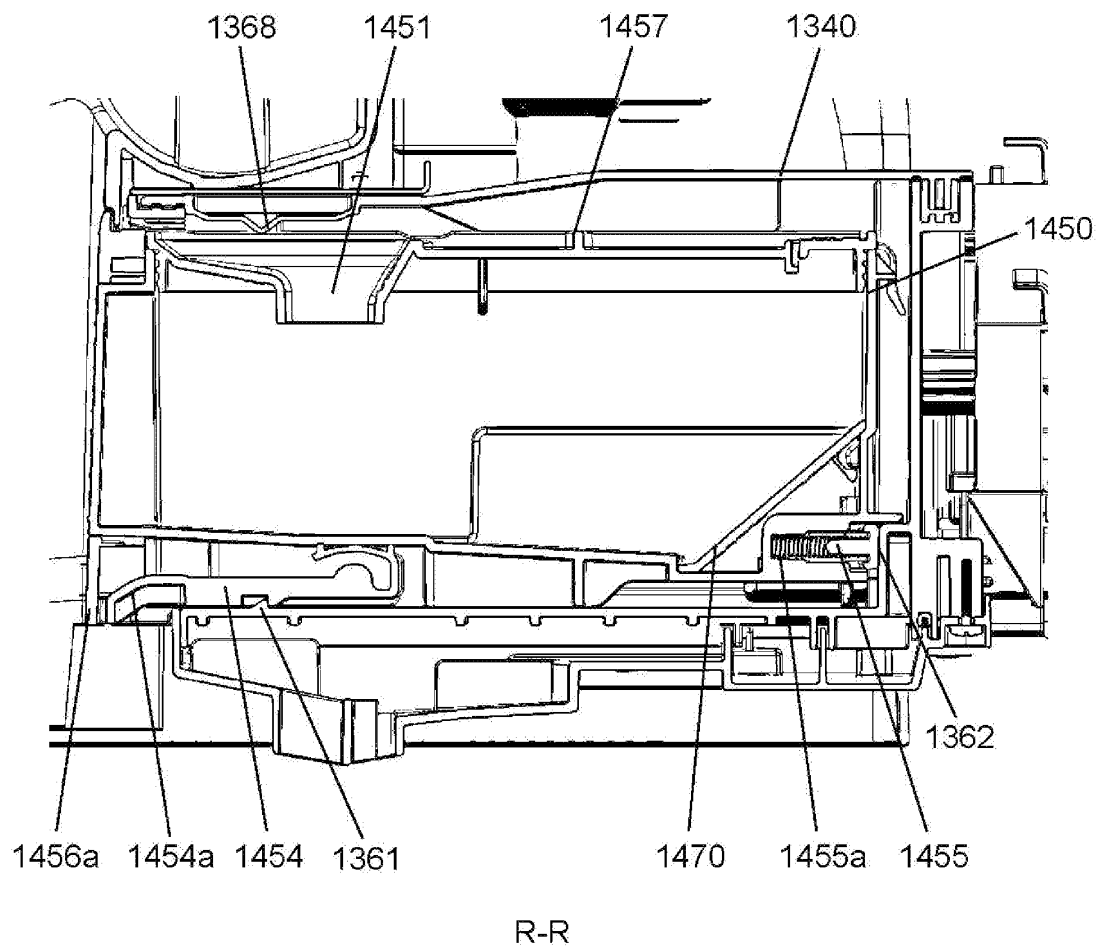
[図39A]



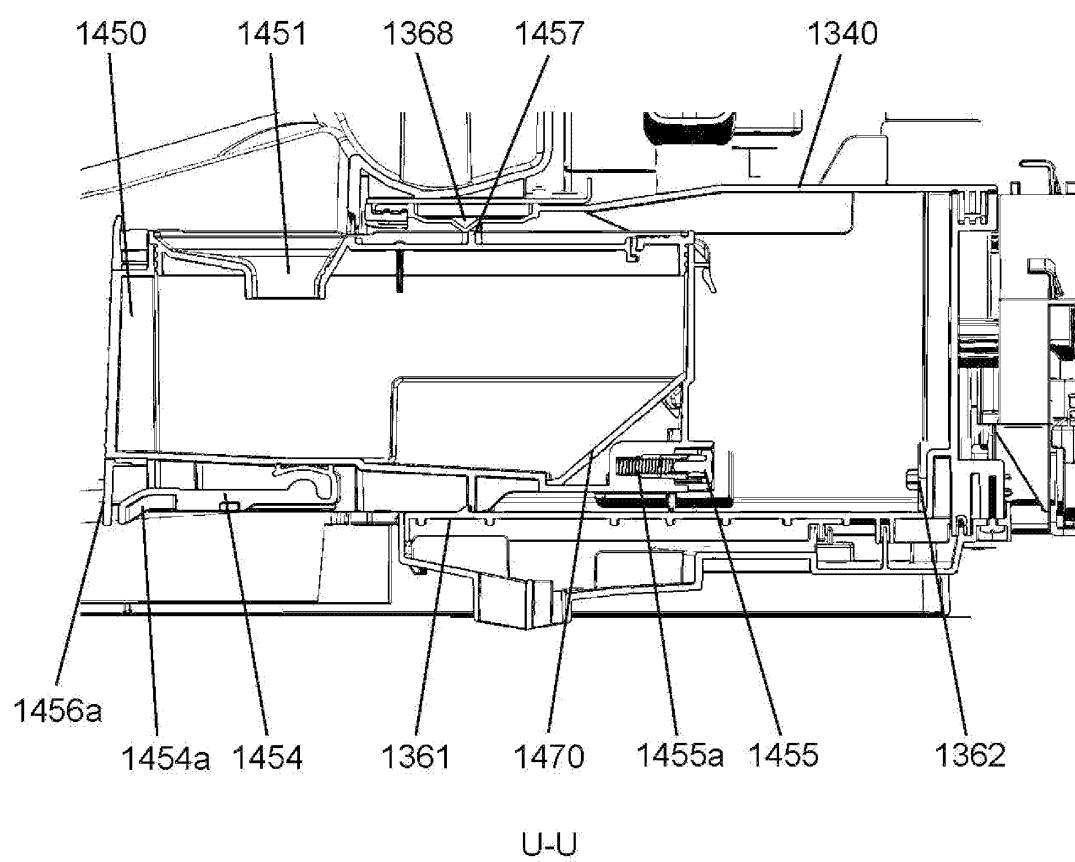
[図39B]



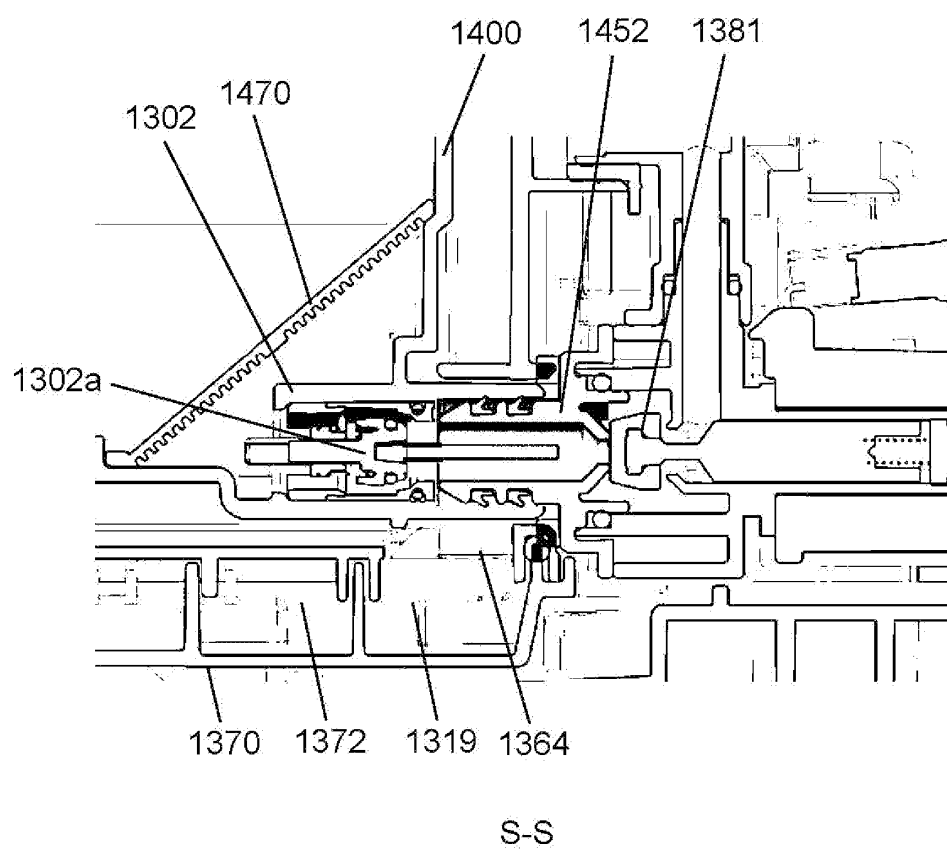
[図40]



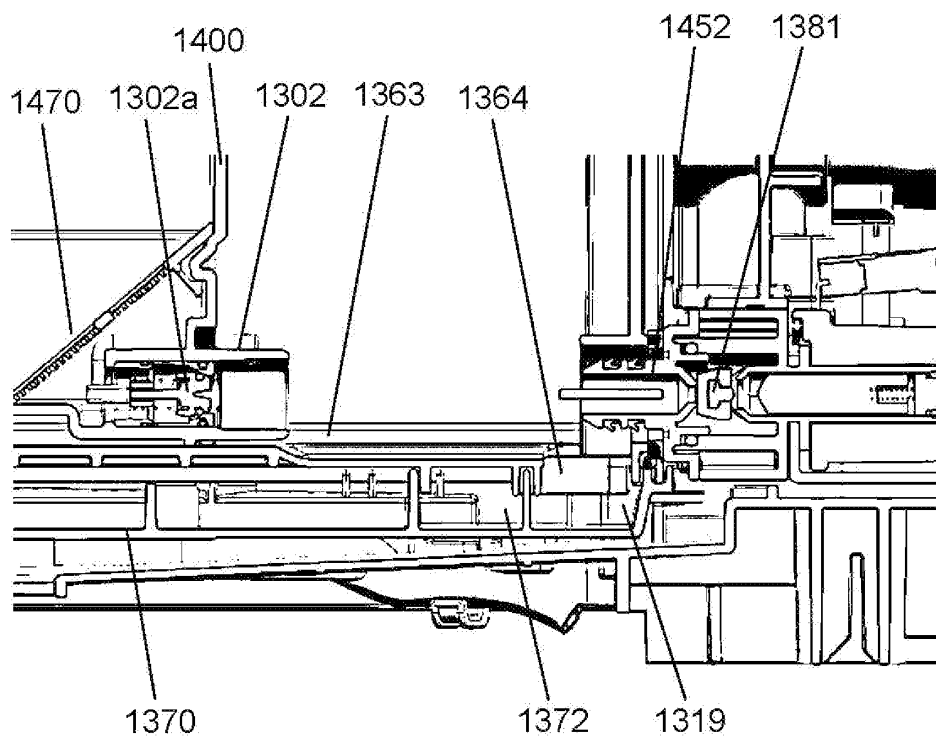
[図41]



[図42]



[図43]



T-T

[図44]

